

Form PTO-1449 (SNL-Modified) (2-91)
 List of Patents and Publications
 for Applicant's
 Information Disclosure Statement
 (use several sheets if necessary)

Atty Docket No: SD-7121/S-98,719
 Serial Number:

APPLICANT: Kenneth A. Peterson, et al
 GROUP: FILING DATE:

jc971 U.S. PTO
 10/08/3454

02/25/02

REFERENCE DESIGNATION

| Ex'r Init | | | U.S. Patent Documents Name | Sub Class | File Date |
|--------------|----|-------------------|-------------------------------|------------------------------------|-----------|
| | | Document No./Date | | Class | |
| LT | AA | 6,335,224 | 6/1/02 | Protection of Microelectronic, ... | 438/114 |
| LT | AB | 5,600,541 | 2/4/97 | Vertical IC Chip Stack... | 361/707 |
| LT | AC | 5,729,038 | 3/17/98 | Silicon-Glass Bonded Wafers | 257/460 |
| LT | AD | 5,357,056 | 10/18/94 | Chip Carrier For Optical Device | 174/524 |
| LT | AE | 5,864,381 | 1/26/99 | Automated Pupil Remapping... | 351/205 |
| LT | AF | 5,493,391 | 2/20/96 | One Dimensional Wavefront... | 356/121 |
| LT | AG | 5,352,852 | 10/4/94 | Charge Coupled Device Package... | 174/52.4 |
| LT | AH | 4,742,182 | 5/3/88 | Flatpack for Hermetic... | 174/52 |
| | | | | | 11/6/86 |

| | | Foreign Patent Documents Name | Sub Class | Translation Yes | No |
|--|-------------------|----------------------------------|--------------|--------------------|----|
| | Document No./Date | | Class | | |

OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)

LT BA | Kenneth A. Peterson, et al; "Pre-Release Plastic Packaging of MEMS and IMEMS Devices" Patent Application 09/572,720 filed 5/16/00.

LT BB | Kenneth A. Peterson, et al, "Microelectronic Device Package with an Integral Window"; Serial No. 09/571,335; filed 5/16/00; Notice of Allowance 2/6/01.

LT BC | M.L. Minges, et al., "Electronic Materials Handbook, Vol. 1, PACKAGING", ASM International, Materials Park, OH, Jan., 1989, pp. 461-469.

Examiner:

LT Hui

Date Considered:

10/2002